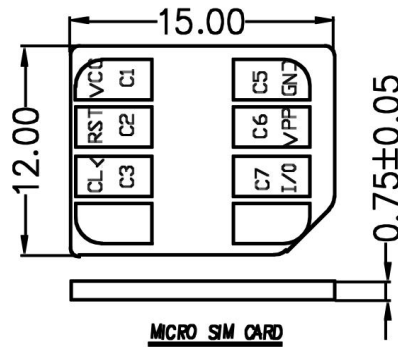


PCB 焊盘区
 下加层板区
RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ±0.05



C1:VCC
C2:RST
C3:CLK
C4:RESERVED
C5:GND
C6:VPP
C7:I/O
C8:RESERVED

MATERIAL:

Insulator High Temperature Thermoplastic, UL94V-0

Contact Copper Alloy

SHELL : SUS

PLATING:

Contact Plated 50u Ni over all Contact Au 1U

Shell plated 50u Ni overall

Plated 1u Au Selective Contact Area

Electrical:

Current Rating:0.5A.

Voltage Rating:30V AC/DC

Ambient Temperature Range: -20 °C +60 °C

Storage Temperature Range : -40 °C +95 °C

Ambient Humidity Range : 95% R.H. Max.

Contact Resistance:100mΩ max.

Insulation Resistance:1000MΩ min./500VDC

产品耐温温度: 260 °C.

Mating Cycles : 1500Min Insertions

东莞市汉博电子科技有限公司

E		TITLE: MICRO SIM CARD	
PART NO.		SIM-200-P6	
PRODUCT SPEC.		MICRO SIM CARD	
FILE NAME.			
SCALE	1:1	UNIT:mm	A4
SHEET:1 of 1			

General	Angle	设计	Brick	14'/05/22
X±0.50	X*±2°	DESIGN		
.X±0.30	.X*±1°	校阅	Brick	14'/05/22
.XX±0.20	.XX*±0.5°	CHECK		
GENERAL TOLERANCE UNLESS OTHERWISE NOTED		承认	jack he	14'/05/22
		APPRO.		